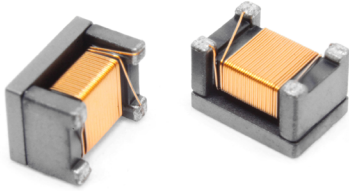


Automotive Chip Choke

EMI Suppression for CAN-Bus Networks

2-Line Common Mode Chokes



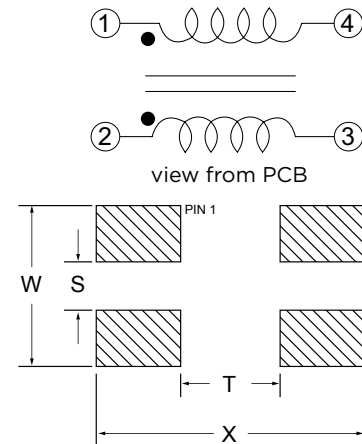
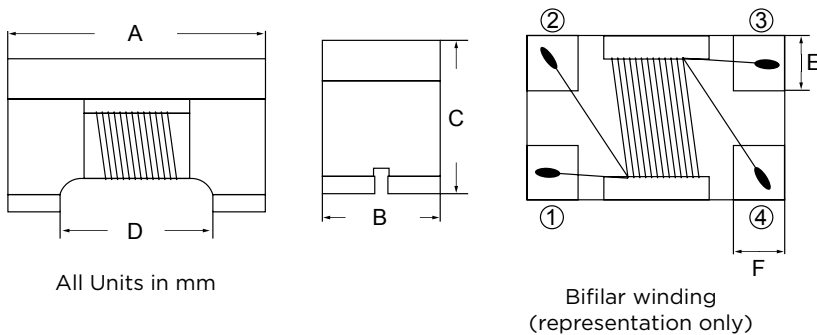
- Meets AEC-Q200 Requirements
- Suppression of common mode noise without attenuating the signal
- Magnetically shielded versions for lower R_{dc} and higher current
- Supports CAN-Bus, A2B and other IVN high speed differential signal lines (LVDS)

Electrical Specifications @ 25°C

Part Number	Common Mode Impedance (10MHZ)		Inductance (uH)	Standard Tolerance	RDC (Ω Max)	Leakage Inductance (nH) MAX	IDC (A MAX)	Isolation Resistance (MΩ) Min	Rated Voltage (V) Max
	Min	Typ							
PE-1812ACCXXXSTS									

Mechanical

Schematic



Component Dimensions (mm)

SOLDER PAD (mm)

Series	A	B	C	D	E	F	X	T	W	S
1812 ACC	4.5 +/-0.20	3.2 +/-0.20	3.0 MAX	3.1 +/-0.20	0.65 +/-0.15	0.70 +/-0.15	5.90	3.20	3.40	1.60

Automotive Chip Choke

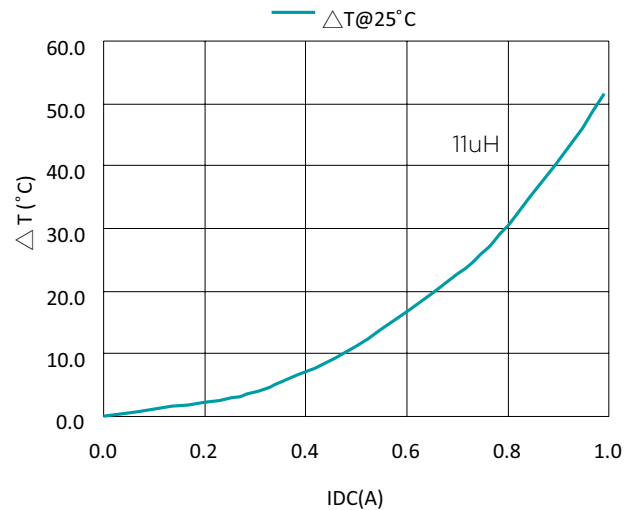
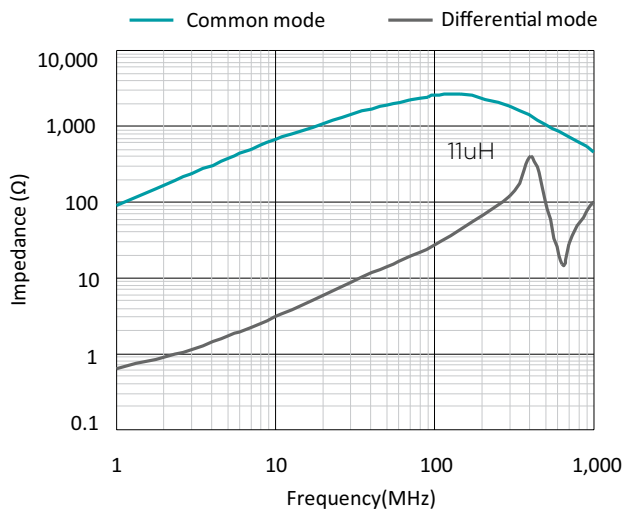
EMI Suppression for CAN-Bus Networks

2-Line Common Mode Chokes

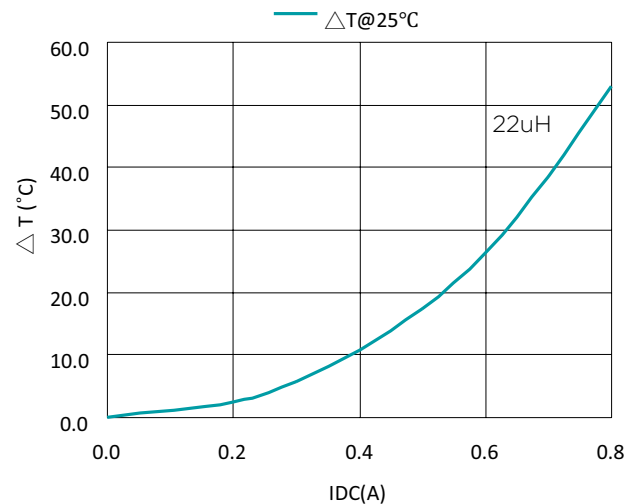
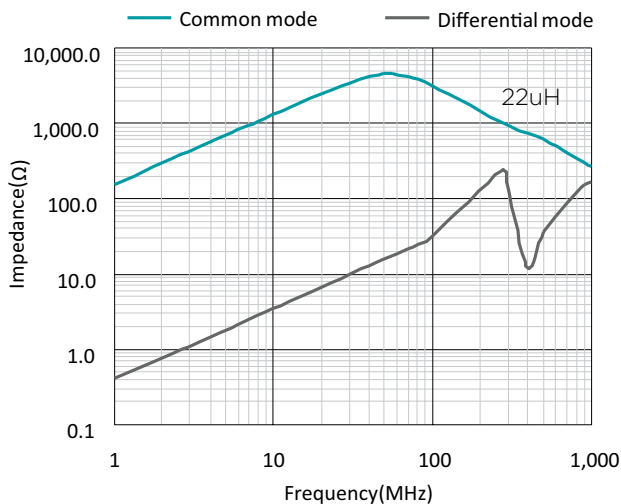
Impedance vs Frequency

Temp vs DC Current

PE-1812ACC110STS



PE-1812ACC220STS



Automotive Chip Choke

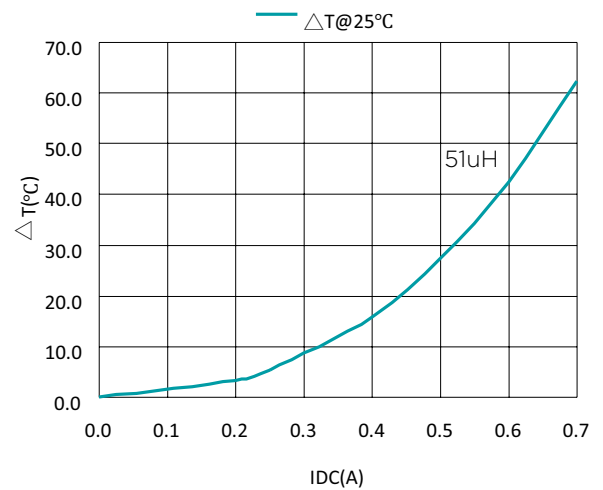
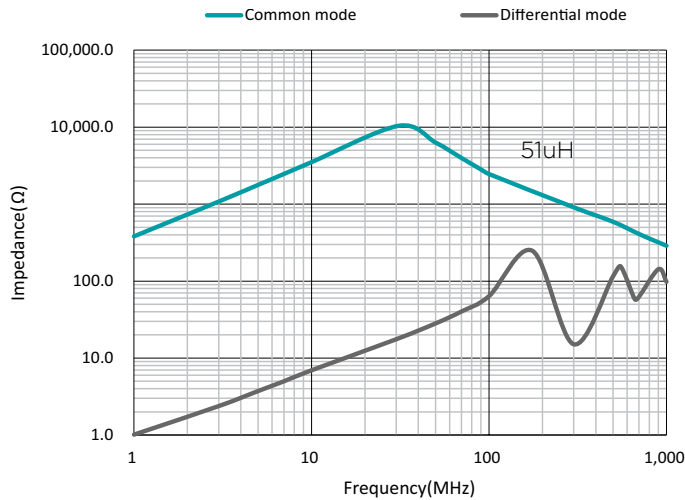
EMI Suppression for CAN-Bus Networks

2-Line Common Mode Chokes

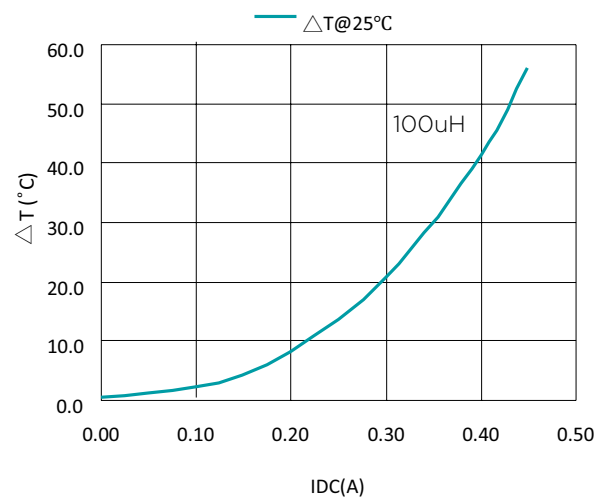
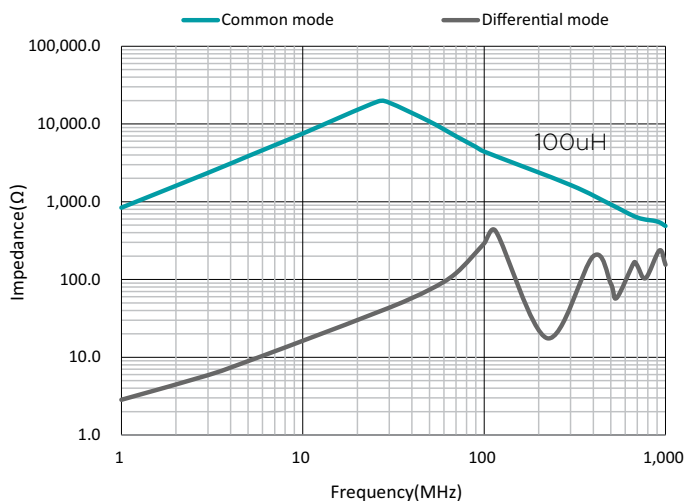
Impedance vs Frequency

Temp vs DC Current

PE-1812ACC510STS



PE-1812ACC101STS



Automotive Chip Choke

EMI Suppression for CAN-Bus Networks

2-Line Common Mode Chokes

Reliability Test

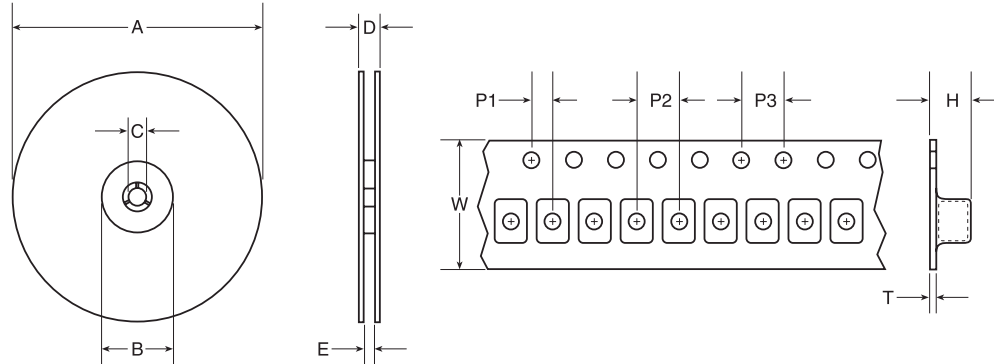
Item	Reference documents	Test Condition	Test Specification
1. High Temperature Exposure	MIL-STD-202 Method 108	1. Temperature: 125°C 2. Time: 1000 hours	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
2. Temperature Cycling	JESD22 Method JA-104	1. Temperature: -40°C~125°C 2. Number of cycles: 1000 cycle 3. Dwell time: 30 minutes	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
3. Biased Humidity Test	MIL-STD-202 Method 103	1. Temperature: 85 ± 5 °C 2. Time: 1000 hours 3. Humidity: 85 $\pm 5\%$ RH	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
4. Operational Life	MIL-PRF-27	1. Temperature: 125°C 2. Time: 1000 hours 3. Apply rated current	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
5. External Visual	MIL-STD-883 Method 2009	Inspect product construction, marking and workmanship	Per product specification standard
6. Physical Dimensions	JESD22 Method JB-100	Verify physical dimensions to the applicable product detail specification	Per product specification standard
7. Resistance to solvents	MIL-STD-202 Method 215	Immerse into solvent for 3 ± 0.5 minutes & brush 10 times for their cycles.	1. No body change in appearance 2. No marking blurred. 3. Inductance shall not change more than $\pm 30\%$
8. Vibration Test	MIL-STD-202 Method 204	1. Frequency and Amplified: 10-2000-10 Hz, 1.5mm 2. Direction: X, Y, Z 3. Test duration: 2 hours for each direction, 6 hours in total	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
9. Resistance to Soldering Heat Test	MIL-STD-202 Method 210	1. Temperature: 250 ± 5 °C 2. Time: (temp. ≥ 217 °C) 92-109 Seconds 3. IR reflow times: 3 times	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
10. Rated Current	MIL-STD-202 Method 330	Apply rated current for 5 seconds.	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
11. Temperature Rise	MIL-PRF-27	Apply rated current for 10 minutes.	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
12. Over load	MIL-PRF-27	Apply twice as rated current for 5 minutes.	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
13. Solderability Test	J-STD-002	1. Bakeing in pre-testing: 150 ± 5 °C / 16Hours ± 30 min. 2. Peak temperature: 245°C 3. Time: (temp. ≥ 217 °C) 112 Second 4. IR reflow times: 1 time	The terminal shall be at least 95% covered with fresh solder.
14. Electrical Characterization	User Spec.	1. Operating temperature: -40°C~125°C 2. Room Temperature: 25°C	1. No mechanical and electrical damage 2. Inductance shall not change more than $\pm 30\%$
15. Withstanding Voltage Test	MIL-STD-202 Method 201	1. DV: 500V 2. Time: 1 minute	1. During the test no breakdown. 2. The characteristic is normal after test.
16. Drop	JESD22-B111	Package & Drop down from 1m. In 1 angle 1 ridge & 2 surfaces orientation	1. No case deformation or change in appearance. 2. Inductance shall not change more than $\pm 30\%$
17. Terminal Strength Test	JIS-C-6429	1. Apply push force to samples mounted on PCB. 2. Force of 1.8 kg for 60 ± 1 seconds.	After test, inductors shall be on mechanical damage.

Automotive Chip Choke

EMI Suppression for CAN-Bus Networks

2-Line Common Mode Chokes

Tape and Reel Specifications



Series	Parts per Reel	Reel Dimensions (mm)					Tape Dimensions (mm)					
		A	B	C	D	E	W	P1	P2	P3	H	T
1812 ACC	500	178	60	13	17	14	12	2	8	4	4	0.35

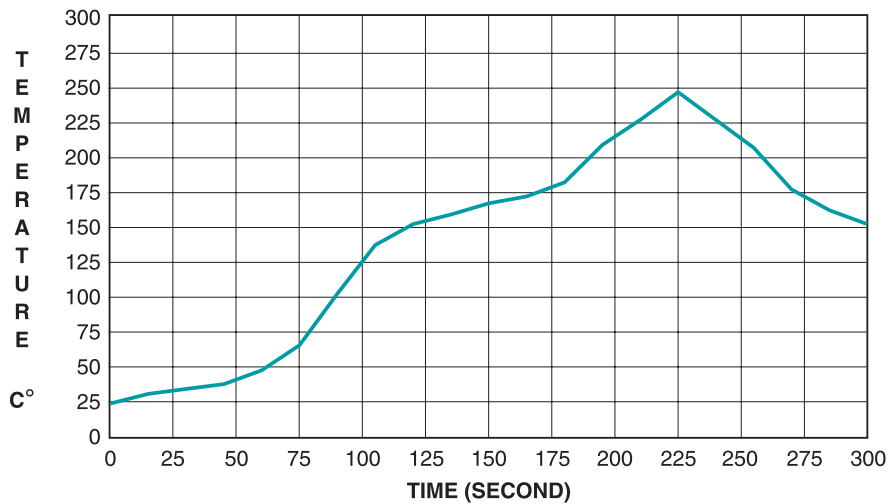
I. Description:

- Ferrite drum core construction
- Magnetically shielded
- Enameled copper wire: H class
- Product weight: 0.15g (ref.)
- Moisture sensitivity Level 1
- Products comply with RoHS' requirements
- Halogen Free available

II. General specification:

- Storage temp: -40°C to +125°C
- Operating temp: -40°C to +125°C
(Temp. rise included)
- Resistance to solder heat: 250°C 10 secs.

Recommended Solder Heat Resistance Profile



For More Information:

Americas - prodinfo@networkamericas@pulseelectronics.com | Europe - comms-Apps-Europe@pulseelectronics.com | Asia - prodinfo@networkapac@pulseelectronics.com

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